1.8mm SOLID STATE LAMP

Part Number: WP4060GD

Green

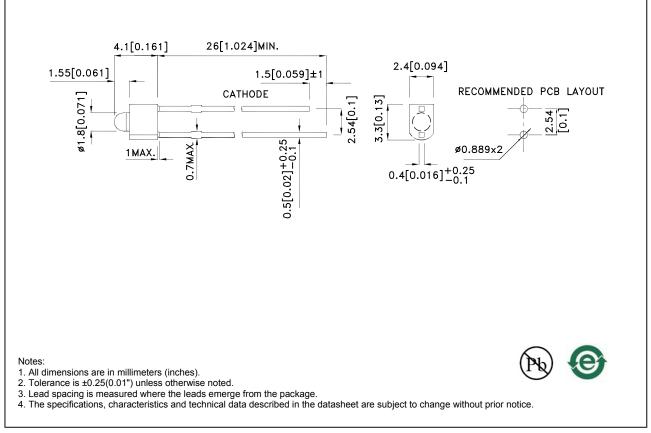
Features

- 1.8mm diameter small size LED lamp.
- Versatile mounting on P.C. board or panel.
- Reliable and rugged.
- RoHS compliant.

Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



REV NO: V.5B CHECKED: Allen Liu DATE: JAN/17/2015 **DRAWN: P.Cheng**

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Selection Guide

| Part No. | Dice | Lens Type | lv (mcd) [2] @ 10mA | | Viewing Angle [1] |
|----------|-------------|----------------|------------------------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| WP4060GD | Green (GaP) | Green Diffused | 6 | 12 | 70° |

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|--------|------|------|-------|-----------------|
| λpeak | Peak Wavelength | Green | 565 | | nm | I⊧=20mA |
| λD [1] | Dominant Wavelength | Green | 568 | | nm | I⊧=20mA |
| Δλ1/2 | Spectral Line Half-width | Green | 30 | | nm | IF=20mA |
| С | Capacitance | Green | 15 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green | 2.2 | 2.5 | V | I⊧=20mA |
| lr | Reverse Current | Green | | 10 | uA | VR = 5V |

Notes: 1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

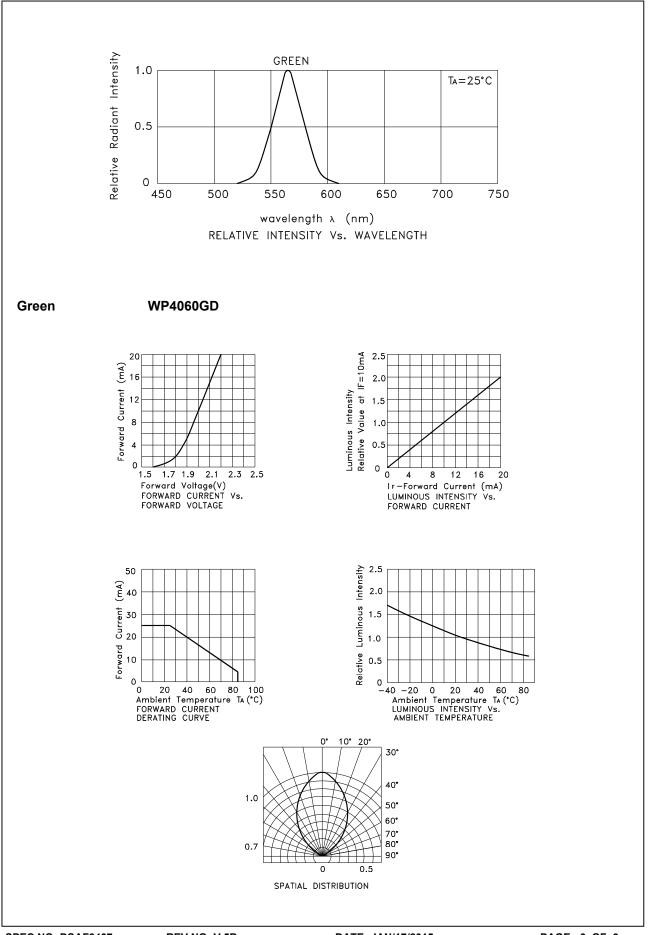
Absolute Maximum Ratings at TA=25°C

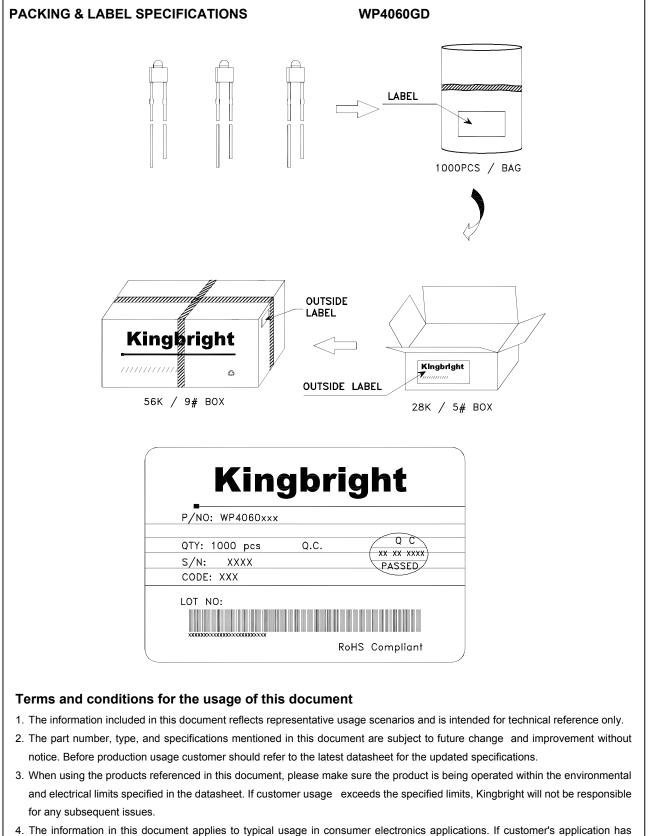
| Parameter | Green | Units | | |
|-------------------------------|---------------------|-------|--|--|
| Power dissipation | 62.5 | mW | | |
| DC Forward Current | 25 | mA | | |
| Peak Forward Current [1] | 140 | mA | | |
| Reverse Voltage | 5 | V | | |
| Operating/Storage Temperature | -40°C To +85°C | | | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | | | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | | | |

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.

3. 5mm below package base.



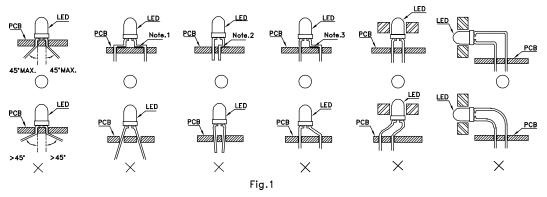


- special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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DATE: JAN/17/2015 DRAWN: P.Cheng

PRECAUTIONS

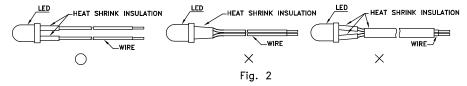
- 1. Storage conditions:
 - a.Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
 - b.LEDs should be stored with temperature $\leq 30^{\circ}$ C and relative humidity < 60%.
 - c.Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.
- 2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



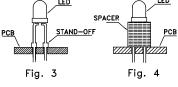
" \bigcirc " Correct mounting method "imes" Incorrect mounting method

Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

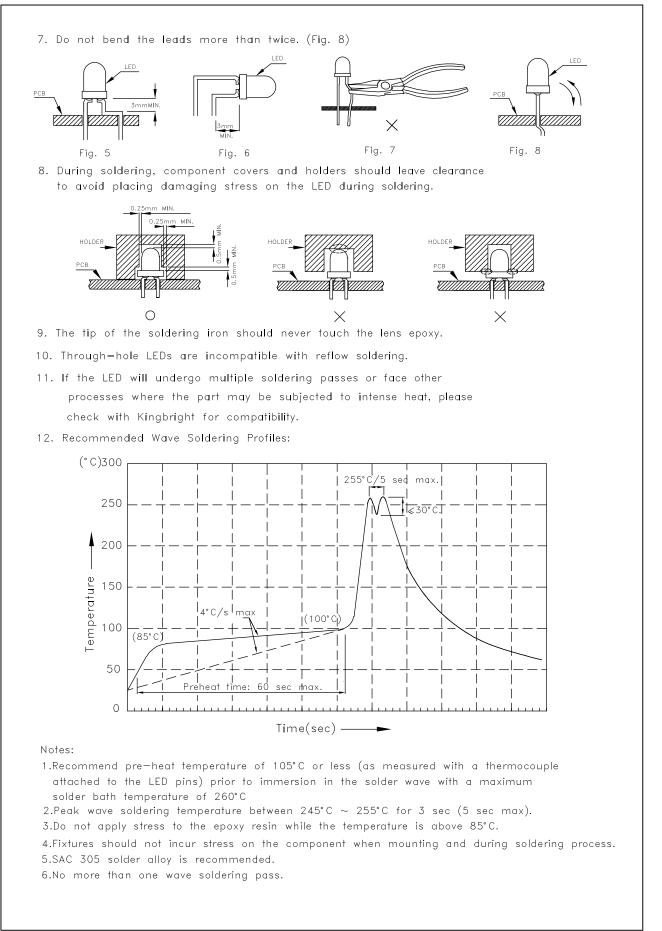
3. When soldering wires to the LED, each wire joint should be separately insulated with heat-shrink tube to prevent short-circuit contact. Do not bundle both wires in one heat shrink tube to avoid pinching the LED leads. Pinching stress on the LED leads may damage the internal structures and cause failure. (Fig. 2)



4. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 5. Maintain a minimum of 3mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 6. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



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